

1.5V Drive Pch+Pch MOSFET

TT8J1

●Structure

Silicon P-channel MOSFET

●Features

- 1) Low On-resistance.
- 2) High Power Package.
- 3) Low voltage drive. (1.5V)

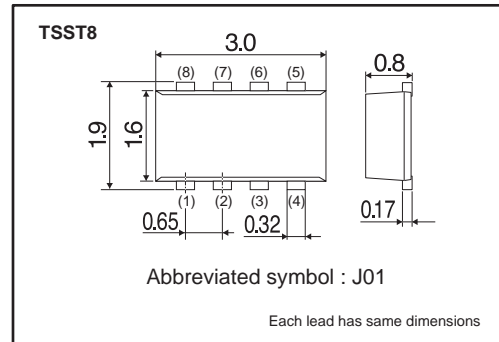
●Applications

Switching

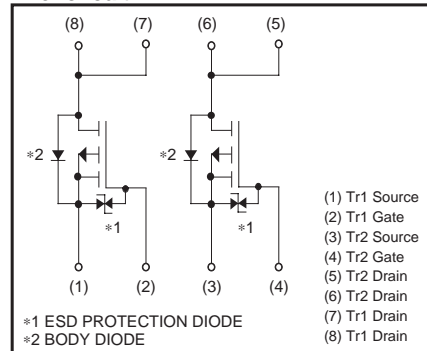
●Packaging specifications

Type	Package	Taping
	Code	TR
	Basic ordering unit (pieces)	3000
TT8J1		○

●Dimensions (Unit : mm)



●Inner circuit



●Absolute maximum ratings (Ta=25°C)

<It is the same ratings for the Tr1 and Tr2.>

Parameter	Symbol	Limits	Unit	
Drain-source voltage	V_{DS}	-12	V	
Gate-source voltage	V_{GS}	±10	V	
Drain current	Continuous	I_D	±2.5	A
	Pulsed	I_{DP} *1	±10	A
Source current (Body diode)	Continuous	I_S	-0.8	A
	Pulsed	I_{SP} *1	-10	A
Total power dissipation	P_D *2	1.25	W / TOTAL	
		1.0	W / ELEMENT	
Channel temperature	T_{ch}	150	°C	
Range of Storage temperature	T_{stg}	-55 to +150	°C	

*1 $P_{ws} \leq 10 \mu s$, Duty cycles $\leq 1\%$

*2 Mounted on a ceramic board

●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	$R_{th(ch-a)}$ *	100	°C / W / TOTAL
		125	°C / W / ELEMENT

* Mounted on a ceramic board

●Electrical characteristics (Ta=25°C)

<It is the same characteristics for the Tr1 and Tr2.>

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	-	-	± 10	μA	$V_{GS}=\pm 10V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	-12	-	-	V	$I_D=-1mA, V_{GS}=0V$
Zero gate voltage drain current	I_{DSS}	-	-	-1	μA	$V_{DS}=-12V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	-0.3	-	-1.0	V	$V_{DS}=-6V, I_D=-1mA$
Static drain-source on-state resistance	$R_{DS(on)}$ *	-	44	61	m Ω	$I_D=-2.5A, V_{GS}=-4.5V$
		-	60	84	m Ω	$I_D=-1.2A, V_{GS}=-2.5V$
		-	81	121	m Ω	$I_D=-1.2A, V_{GS}=-1.8V$
		-	110	220	m Ω	$I_D=-0.5A, V_{GS}=-1.5V$
Forward transfer admittance	$ Y_{fs} $ *	3.5	-	-	S	$V_{DS}=-6V, I_D=-2.5A$
Input capacitance	C_{iss}	-	1350	-	pF	$V_{DS}=-6V$
Output capacitance	C_{oss}	-	130	-	pF	$V_{GS}=0V$
Reverse transfer capacitance	C_{rss}	-	125	-	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}$ *	-	9	-	ns	$V_{DD}\dot{=} -6V$
Rise time	t_r *	-	35	-	ns	$V_{GS}=-4.5V$
Turn-off delay time	$t_{d(off)}$ *	-	130	-	ns	$I_D=-1.2A$
Fall time	t_f *	-	85	-	ns	$R_L\dot{=} 5\Omega$
Total gate charge	Q_g *	-	13	-	nC	$V_{DD}\dot{=} -6V$
Gate-source charge	Q_{gs} *	-	2.5	-	nC	$V_{GS}=-4.5V$
Gate-drain charge	Q_{gd} *	-	2.0	-	nC	$I_D=-2.5A$ $R_L\dot{=} 2.4\Omega / R_G=10\Omega$

*Pulsed

●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_{SD} *	-	-	-1.2	V	$I_S=-2.5A, V_{GS}=0V$

* Pulsed

●Electrical characteristic curves

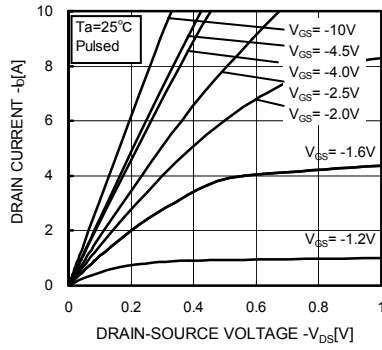


Fig.1 Typical Output Characteristics(I)

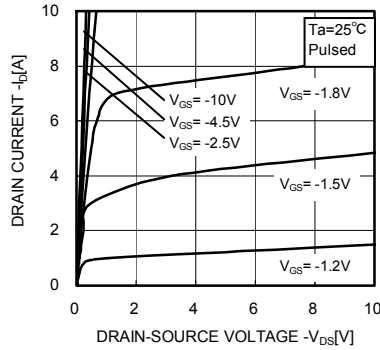


Fig.2 Typical Output Characteristics(II)

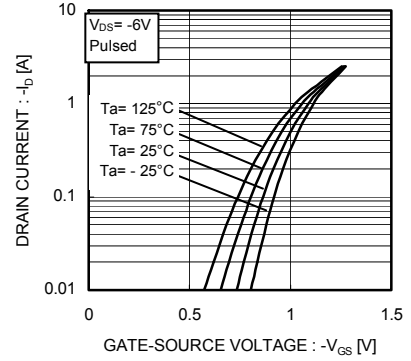


Fig.3 Typical Transfer Characteristics

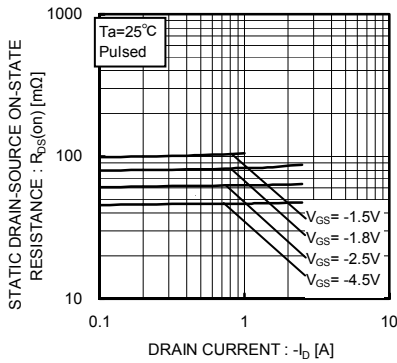


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(I)

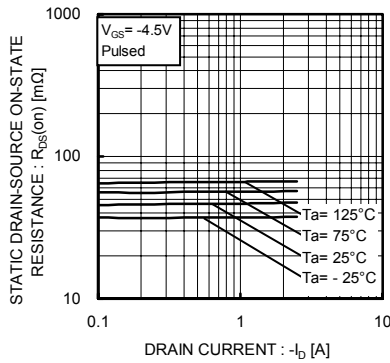


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(II)

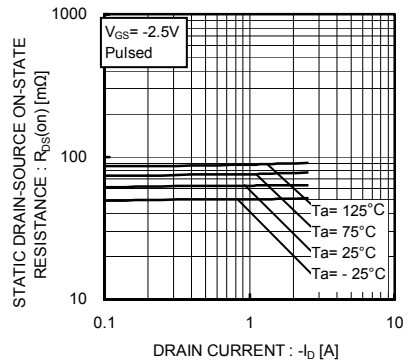


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(III)

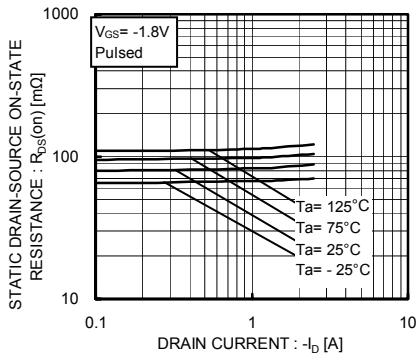


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(IV)

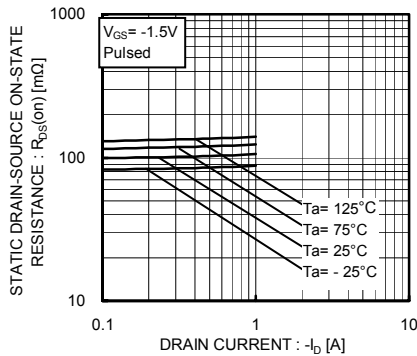


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current(V)

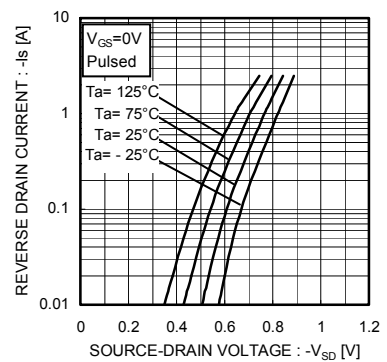


Fig.9 Reverse Drain Current vs. Source-Drain Voltage

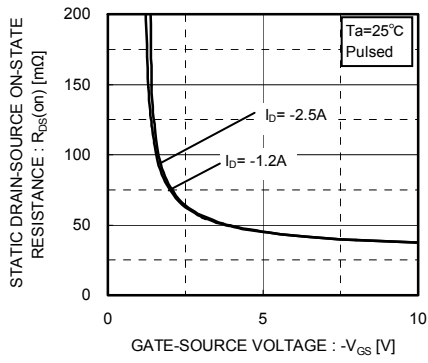


Fig.10 Static Drain-Source On-State Resistance vs. Gate Source Voltage

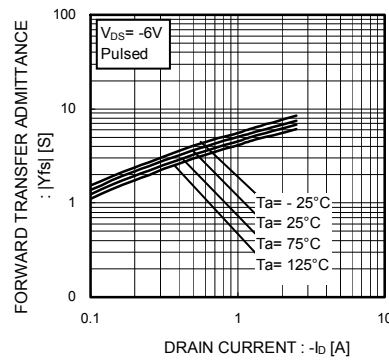


Fig.11 Forward Transfer Admittance vs. Drain Current

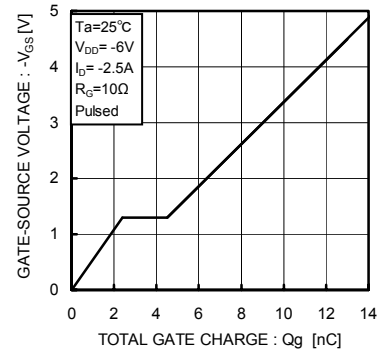


Fig.12 Dynamic Input Characteristics

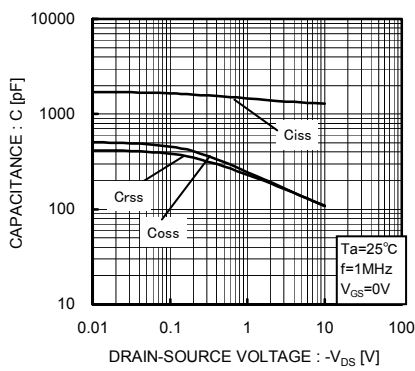


Fig.13 Typical Capacitance vs. Drain-Source Voltage

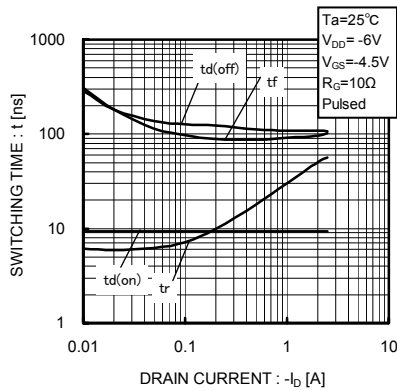


Fig.14 Switching Characteristics

●Measurement circuits

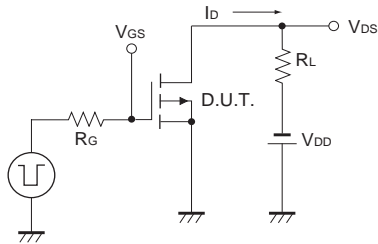


Fig.1-1 Switching Time Measurement Circuit

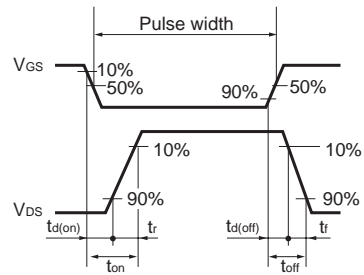


Fig.1-2 Switching Waveforms

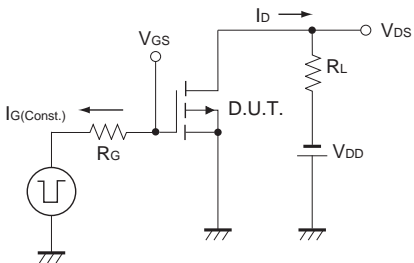


Fig.2-1 Gate Charge Measurement Circuit

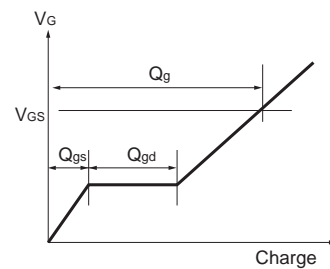


Fig.2-2 Gate Charge Waveform

●Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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